



## Applications

- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- Battery Chargers
- Motor Drives
- Pulsed Power applications

## Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

## Benefits

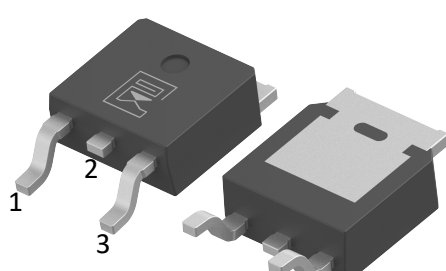
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

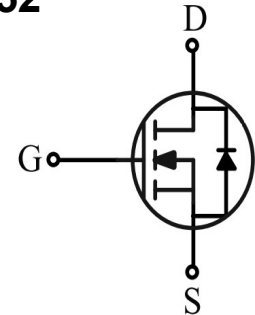
## Product Summary

$V_{DS}$	650	V
$I_D$	6	A
$R_{DS(ON)}, Typ@15V$	1000	mΩ
$Q_g$	17	nC



**TO-252**





Gate: 1  
Drain: 2  
Source: 3

## Package Marking and Ordering Information

Ordering code	Marking	Package	Packaging	Min. package quantity
MK3C1K0R065	MK3C1K0R065	TO-252	Tape & Reel	3000



## 》 Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DS}$	650	V
Gate-Source Voltage	$V_{GS}$	- 10/+22	V
Recommended operational values	$V_{GSop}$	0/+18	V
Continuous Drain Current Tc=25°C VGS=15V (Note 1)	$I_D$	6	A
Continuous Drain Current Tc=100°C VGS=15V (Note 1)		4	A
Drain Current-Pulsed (Note 1)	$I_{DM}$	12	A
Total Dissipation	$P_D$	47	W
Junction Temperature	$T_j$	175	°C
Storage Temperature	$T_{stg}$	- 55~175	°C
Single Pulse Avalanche Energy (Note 2)	$E_{AS}$	16	mJ

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

## 》 Thermal Characteristics

Parameter	Symbol	Max	Unit
Maximum Junction-to-Case	$R_{\theta JC}$	3.2	°C/W
Maximum Junction-to-Ambient	$R_{\theta JA}$	60	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

Note 2: VDD=100V, Tch= 25°C(initial), L=0.5mH

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

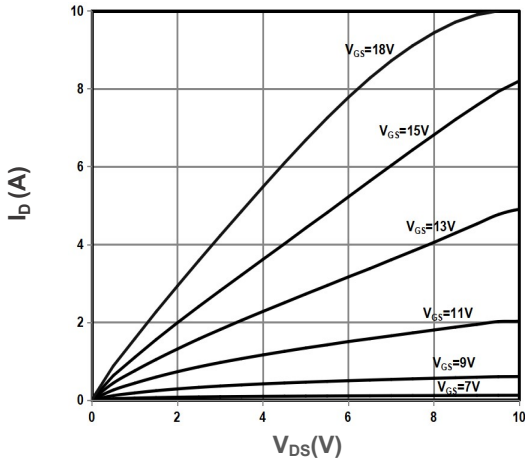


Electrical Characteristics (Tc=25°C unless otherwise noted)

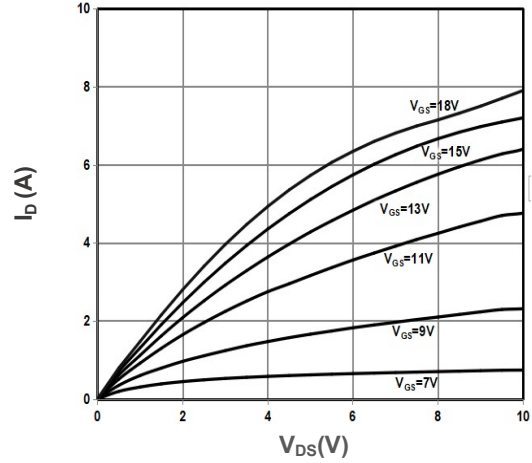
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=500\mu A$	650	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=650V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=18V, V_{DS}=0V$	-	-	100	nA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_{DS}=1mA$	3.0	3.7	4.5	V
Drain-Source On Resistance	$R_{DS(ON)}$	$V_{GS}=15V, I_D=1.8A$	-	1000	1250	m $\Omega$
		$T_j=175^\circ C$	-	780	-	
		$V_{GS}=18V, I_D=1.8A$	-	700	900	
		$T_j=175^\circ C$	-	650	-	
Transconductance	$g_{fs}$	$V_{GS}=20V, I_D=3A$	-	1.2	-	S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V,$ $f=1.0MHz$	-	129	-	pF
Output Capacitance	$C_{oss}$		-	35	-	pF
Reverse Transfer Capacitance	$C_{rss}$		-	2	-	pF
Gate Resistance	$R_g$	$V_{DS}=0V, V_{GS}=0V,$ $f=1.0MHz$	-	11	-	$\Omega$
<b>Switching Parameters</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=500V,$ $V_{GS}=0/18V$ $I_D=2A,$ $R_{G(ext)}=2\Omega$	-	13	-	ns
Turn-On Rise Time	$t_r$		-	38	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	24	-	ns
Turn-Off Fall Time	$t_f$		-	108	-	ns
Turn-On Switching Energy	$E_{ON}$		-	15	-	$\mu J$
Turn-Off Switching Energy	$E_{OFF}$		-	3.5	-	
Total Gate Charge	$Q_g$	$V_{DD}=500V$ $V_{GS}=0/15V$ $I_D=2A$	-	17	-	nC
Gate-Source Charge	$Q_{gs}$		-	7	-	nC
Gate-Drain Charge	$Q_{gd}$		-	7	-	nC
<b>Source-Drain Characteristics</b>						
Diode Forward Voltage	$V_{sd}$	$V_{GS}=0V, I_{SD}=2A$	-	4.2	-	V
Continuous Diode Forward Current	$I_S$	$T_C=25^\circ C$	-	6	-	A
Reverse Recovery Time	$t_{rr}$	$V_R=400V, I_F=6A,$ $di/dt=200A/\mu s$	-	8.3	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	4.6	-	nC
Peak Reverse Recovery Current	$I_{rrm}$		-	1.1	-	A



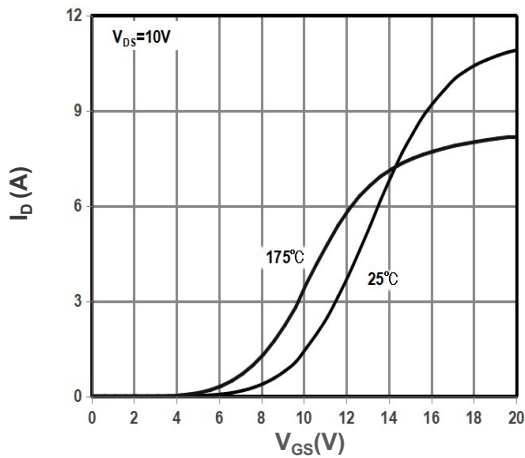
Characteristics Curves



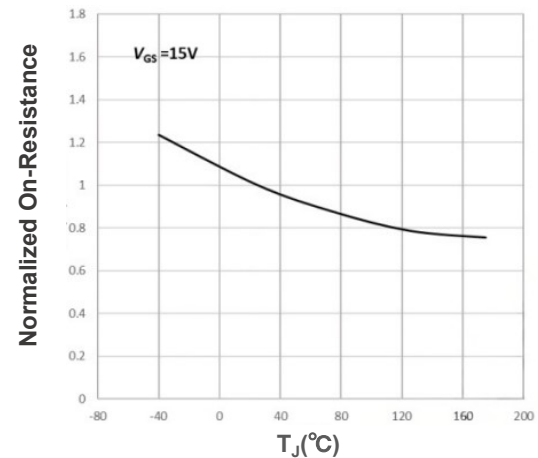
Output Characteristics  $T_J = 25^\circ\text{C}$



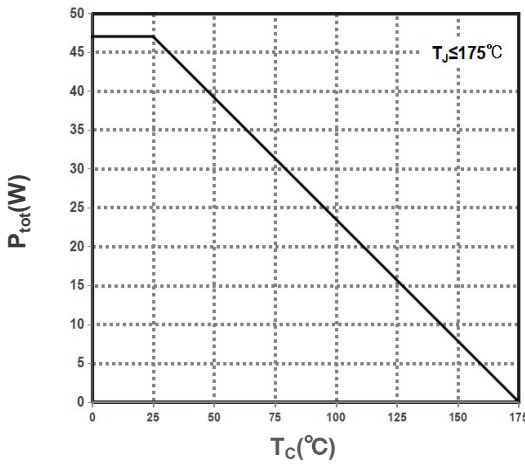
Output Characteristics  $T_J = 175^\circ\text{C}$



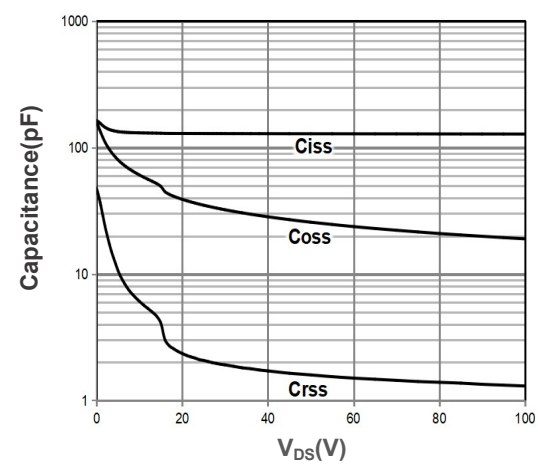
Transfer Characteristics



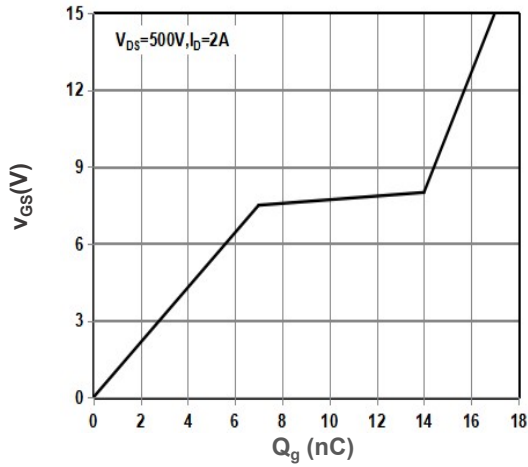
Normalized On-Resistance vs. Temperature



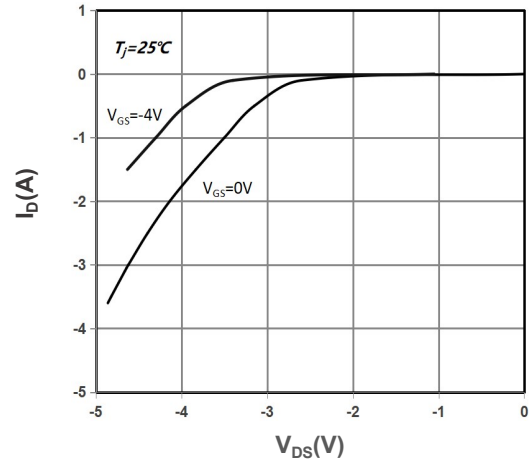
Power Dissipation Derating



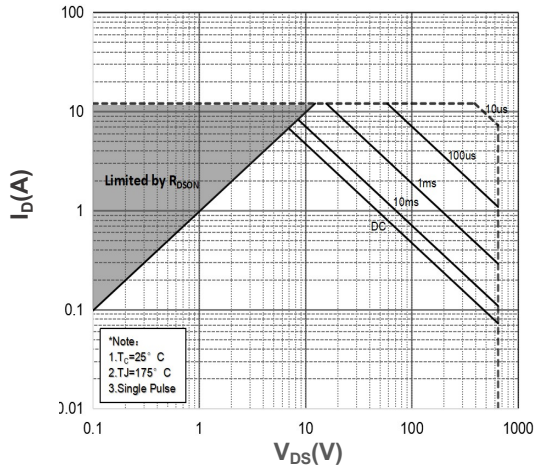
Capacitance



Gate Charge Waveform



Source-Drain Diode Characteristics,  $T_J=25^{\circ}C$



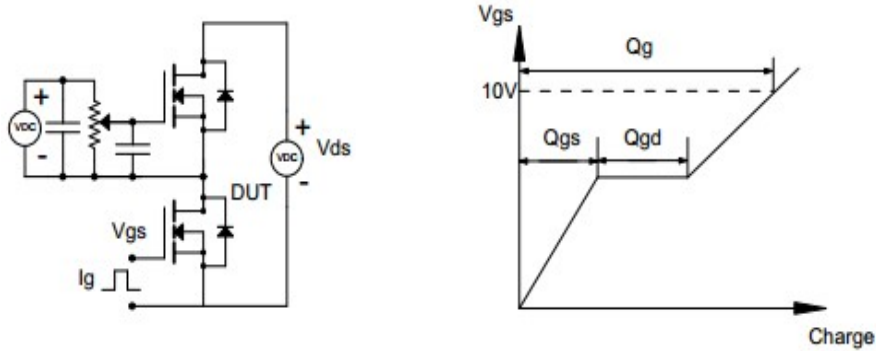
Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

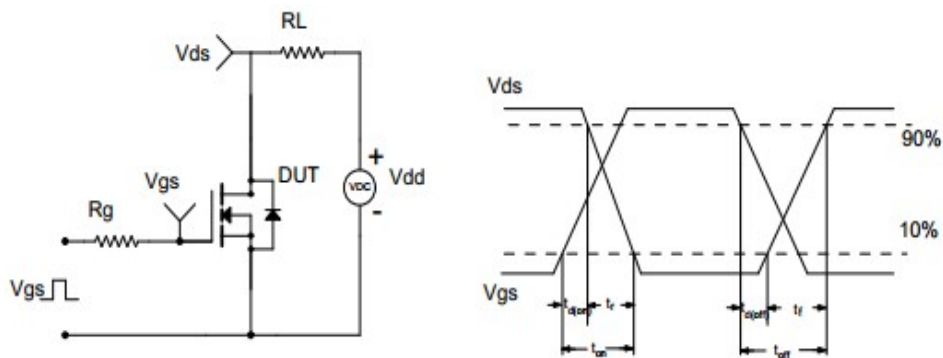


» Test Circuit & Waveform

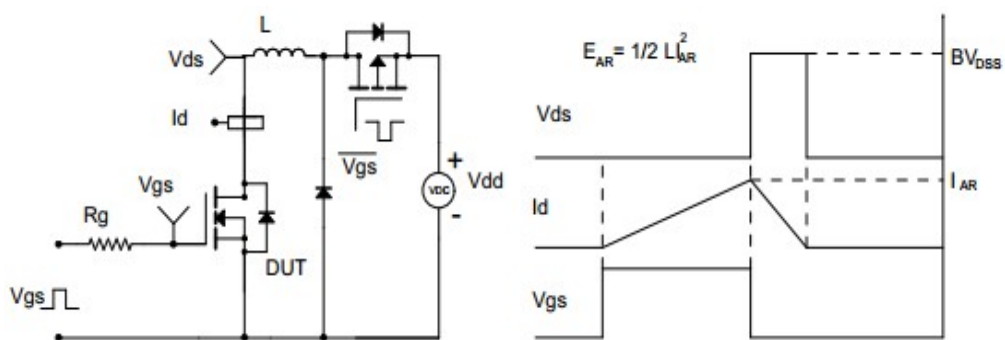
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching (UIS) Test Circuit & Waveform





» TO-252 Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	2.20		2.40	L	9.80		10.40
A1	0.00		0.13	L1		2.90	
b	0.66		0.86	L2	1.40		1.60
c	0.46		0.58	L3		1.80	
D	6.50		6.70	L4	0.60		1.00
D1	5.10		5.46	L5	0.90		1.25
D2		4.83		Φ	1.1		1.30
E	6.00		6.20	θ	0°		8°
e	2.19		2.39	V		5.35	

